

RoHS

2.7V to 3.6V

2.7V to 5.5V

±400mA(Max)

±600mA(Max)

-20°C to +85°C

1.5Ω(Typ)

1.1Ω(Typ)

1MHz to 27.5MHz

Free

## System Lens Drivers

# $\mu$ -step System Lens Driver for Digital Still Cameras

# BU24024GU

### General Description

BU24024GU is a system Lens Driver that uses  $\mu$ -step driving to make the configuration of the sophisticated, high precision and low noise lens driver system possible. This IC has a built-in driver for both DC motor and voice coil motor and a  $\mu$ -step controller that decreases CPU power. Therefore, multifunctional lens can be applied.

#### Features

- Built-in 7 channels Driver block 1ch-5ch: Voltage control type H-bridge (Adaptable to STM 2systems) 6,7ch: Current control type H-bridge
- Built-in 2 channels PI driving circuit

#### Applications

Digital still cameras

Typical Application Circuit

## 

FET ON Resistance (1ch-5ch): FET ON Resistance (6ch,7ch):

Key Specifications

**Operating Temperature Range:** 

**Digital Power Supply Voltage:** 

Driver Power Supply Voltage:

Output Current (5ch):

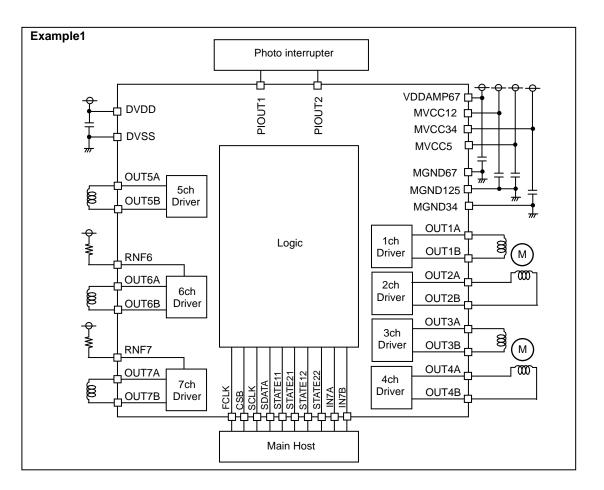
Input Clock Frequency:

Output Current (1ch-4ch,6ch,7ch):

#### Package

VCSP85H3

3.50mm x 3.60mm x 1.00mm



#### OProduct structure : Silicon monolithic integrated circuit OThis product is not designed for protection against radioactive rays

## BU24024GU

## Pin Configuration

G

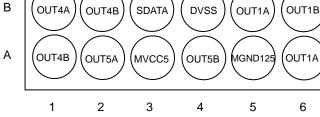
F

Е

D

С

(Bottom view) RNF7 OUT6A RNF6 OUT7B OUT7A (MGND67 VDD AMP67 OUT3A RNF7 IN7A RNF6 OUT6B MVCC34 PIOUT2 STATE12 STATE11 IN7B OUT2B OUT2A OUT3B STATE21 SCLK CSB DVDD MGND34 STATE22 PIOUT1 FCLK MVCC12

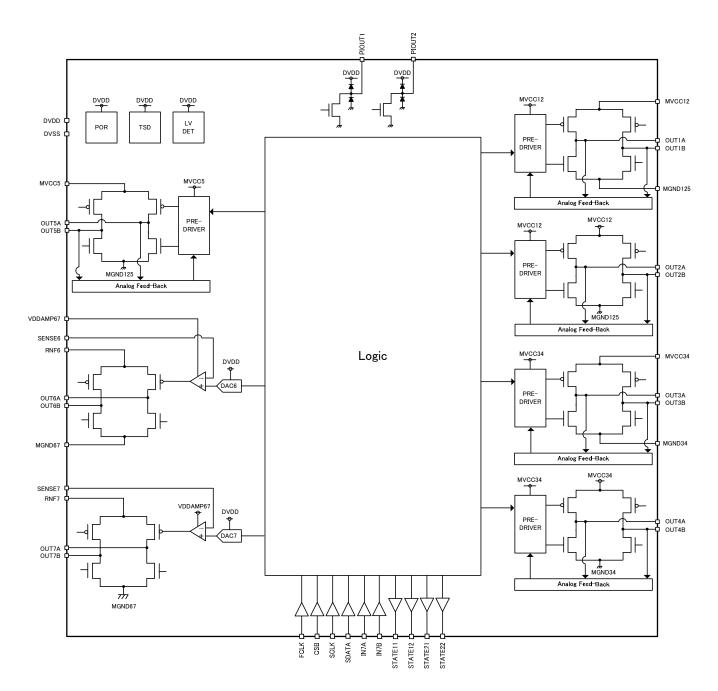


## Pin Description

| Land Pin Name Power Supply |         | Function | Land<br>Matrix No.                | Pin Name  | Power<br>Supply | Function |   |
|----------------------------|---------|----------|-----------------------------------|-----------|-----------------|----------|---|
| D5                         | DVDD    | -        | Digital power supply              | E6        | OUT2B           | MVCC12   | 2-channel<br>driver B output                            |
| B4                         | DVSS    | -        | Digital ground                    | E1        | MVCC34          | -        | 3-4channel<br>driver power supply                       |
| C5                         | FCLK    | DVDD     | FCLK logic input                  | C1        | MGND34          | -        | 3-4channel<br>driver ground                             |
| D4                         | CSB     | DVDD     | CSB logic input                   | F1        | OUT3A           | MVCC34   | 3-channel<br>driver A output                            |
| D3                         | SCLK    | DVDD     | SCLK logic input                  | D1        | OUT3B           | MVCC34   | 3-channel<br>driver B output                            |
| B3                         | SDATA   | DVDD     | SDATA logic input                 | B1        | OUT4A           | MVCC34   | 4-channel<br>driver A output                            |
| F3                         | IN7A    | DVDD     | IN7A logic input                  | A1, B2(*) | OUT4B           | MVCC34   | 4-channel<br>driver B output                            |
| E4                         | IN7B    | DVDD     | IN7B logic input                  | A3        | MVCC5           | -        | 5-channel<br>driver power supply                        |
| E3                         | STATE11 | DVDD     | STATE11 logic output              | A2        | OUT5A           | MVCC5    | 5-channel<br>driver A output                            |
| E2                         | STATE12 | DVDD     | STATE12 logic output              | A4        | OUT5B           | MVCC5    | 5-channel<br>driver B output                            |
| D2                         | STATE21 | DVDD     | STATE21 logic output              | F4        | VDDAMP67        | -        | Power supply of<br>6-7channel<br>current driver control |
| C2                         | STATE22 | DVDD     | STATE22 logic output              | F5, G6(*) | RNF6            | -        | 6-channel<br>driver power supply                        |
| C4                         | PIOUT1  | DVDD     | PI driving output1                | G4        | MGND67          | -        | 6-7channel<br>driver ground                             |
| E5                         | PIOUT2  | DVDD     | PI driving output2                | G5        | OUT6A           | RNF6     | 6-channel<br>driver A output                            |
| C6                         | MVCC12  | -        | 1-2channel<br>driver power supply | F6        | OUT6B           | RNF6     | 6-channel<br>driver B output                            |
| A5                         | MGND125 | -        | 1-2, 5channel<br>driver ground    | F2, G1(*) | RNF7            | -        | 7-channel<br>driver power supply                        |
| A6, B5(*)                  | OUT1A   | MVCC12   | 1-channel driver A output         | G3        | OUT7A           | RNF7     | 7-channel driver A output                               |
| B6                         | OUT1B   | MVCC12   | 1-channel driver B output         | G2        | OUT7B           | RNF7     | 7-channel driver B output                               |
| D6                         | OUT2A   | MVCC12   | 2-channel driver A output         |           |                 |          |   |

OUT2A MVCC12 2-channel driver A output (\*)It is not possible to use corner pin only (Corner pins are A1, A6, G1 and G6.). Please short A1-B2, A6-B5, F2-G1, F5-G6 or use B2, B5, F2, F5 only.

## Block Diagram



## Description of Blocks

Stepping Motor Driver (1ch-4ch Driver)

Built-in stepping motor driver of PWM driving type.

Maximum 2 stepping motors can be driven independently.

Built-in voltage feedback circuit of D-class type.

3ch/4ch drivers can also drive independently for DC motor or voice coil motor.

#### (1)Control

( i ) Autonomous Control

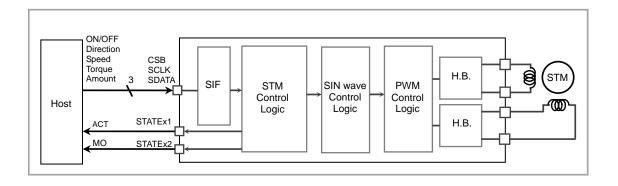
The stepping motor is rotated by setting the registers for the stepping motor control.

It is possible to select the mode of stepping motor control from  $\mu$ -step (1024 portion), 1-2 phase excitation and 2 phase excitation

Built-in Cache registers.

Cache registers enable the setting of subsequent process while the motor is in operation. Through these registers operations are done continuously.

The state of the rotation command (ACT), state of Cache registers (BUSY), motor operation position (MO) and state of excitation (MO & ACT) are synchronized with the motor rotation and can be selected to be the output of the STATE pin.



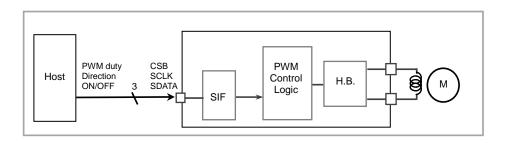
## Description of Blocks

Voltage Driver (5ch Driver) Built-in voltage driver of PWM driving type.

## (1) Control

#### ( i )Register Control

The PWM drive is executed by the PWM duty ratio, the PWM direction and the PWM ON/OFF which are controlled by the register settings.



### Current Driver (6ch Driver)

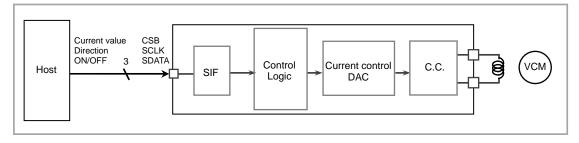
Built-in constant current driver.

The voltage of RNF pin and the external resistor (RRNF) determine the amount of output current. The internal high-precision amplifier (CMOS gate input) is used for constant current control. If any resistance component exists in the wirings of RNF pin and the external resistor (RRNF), the precision can be reduced. To avoid this, pay utmost attention to the wirings.

## (1) Control

( i ) Register Control

The constant current drive is executed by the output current value, the current direction and the current ON/OFF which are controlled by the register settings.



## Description of Blocks

## Current Driver (7ch Driver)

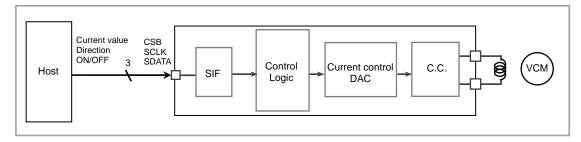
Built-in constant current driver.

The voltage of RNF pin and the external resistor (RRNF) determine the amount of output current. The internal high-precision amplifier (CMOS gate input) is used for constant current control. If any resistance component exists in the wirings of RNF pin and the external resistor (RRNF), the precision can be reduced. To avoid this, pay utmost attention to the wirings.

#### (1) Control

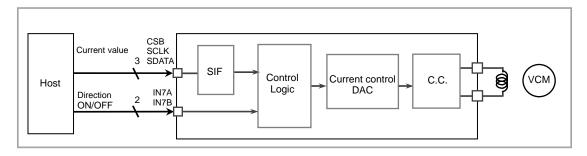
## ( i ) Register Control

The constant current drive is executed by the output current value, the current direction and the current ON/OFF which are controlled by the register settings.



#### (ii) External Pin Control

The constant current drive is executed by the output current value which is controlled by the register setting. Constant current driving direction and turning ON/OFF are controlled by IN7A/IN7B pin.



## ●Absolute Maximum Ratings(Ta=25°C)

| Parameter                   | Symbol | Limit                      | Unit | Remark                               |
|-----------------------------|--------|----------------------------|------|--------------------------------------|
| Dowor Supply Voltage        | DVDD   | -0.3 to +4.5               | V    |                                      |
| Power Supply Voltage        | MVCC   | -0.3 to +7.0               | V    |                                      |
| Input Voltage               | VIN    | -0.3 to supply voltage+0.3 | V    |                                      |
|                             |        | ±400                       | mA   | MVCC12, MVCC34,<br>RNF6 and RNF7 pin |
| Input / Output Current *1   | IIN    | ±600                       | mA   | MVCC5                                |
|                             |        | +50                        | mA   | By PIOUT pin                         |
| Storage Temperature Range   | TSTG   | -55 to +125                | °C   |                                      |
| Operating Temperature Range | TOPE   | -20 to +85                 | °C   |                                      |
| Permissible Dissipation *2  | PD     | 1200                       | mW   |                                      |

\*1 Must not exceed PD.

\*2 To use at a temperature higher than Ta=25 °C, derate 12mW per 1 °C (At mounting 50mm x 58mm x 1.75mm glass epoxy board.)

## ●Recommended Operating Rating (Ta=25°C)

| Parameter                    | Symbol | Limit      | Unit | Remark          |
|------------------------------|--------|------------|------|-----------------|
| Digital Power Supply Voltage | DVDD   | 2.7 to 3.6 | V    | DVDD≦MVCC       |
| Driver Power Supply Voltage  | MVCC   | 2.7 to 5.5 | V    |                 |
| Clock Operating Frequency    | FCLK   | 1 to 27.5  | MHz  | Reference clock |

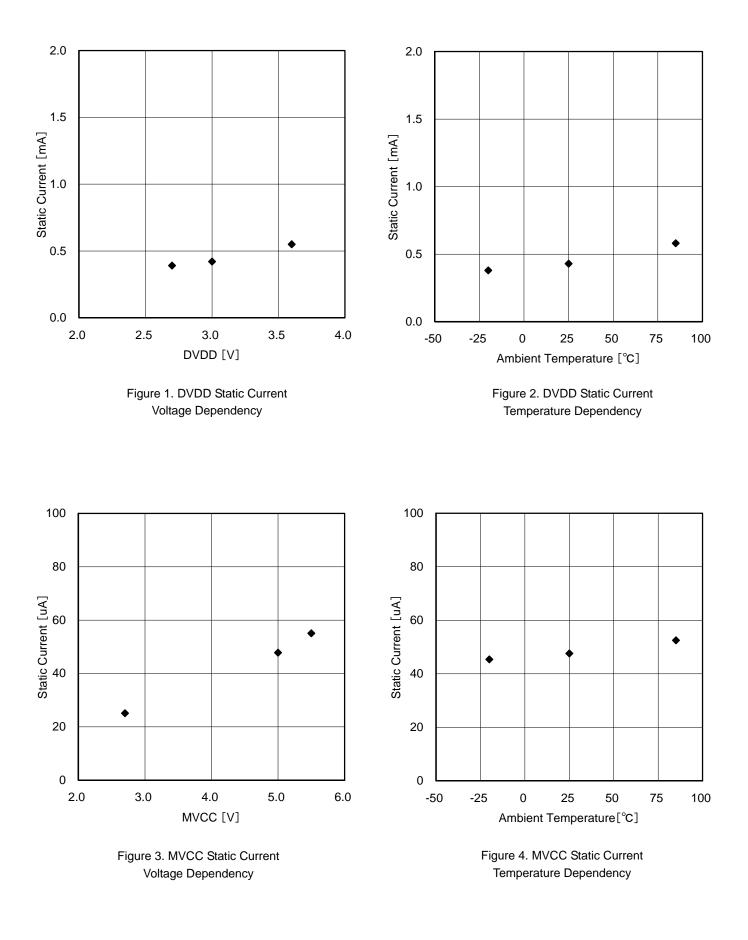
## Electrical Characteristics

(Unless otherwise specified, Ta=25°C, DVDD=3.0V, MVCC=5.0V, DVSS=MGND=0.0V)

| Parameter   |             | Symbol | Symbol Limit |      |         | Unit | Conditions                                      |  |
|---|-------------|--------|--------------|------|---------|------|---|--|
| i aramete   | 1           | Symbol | MIN          | TYP  | MAX     | Onit | Conditions                                      |  |
| <current consumpt<="" td=""><td>ion&gt;</td><td></td><td></td><td></td><td></td><td></td><td></td></current>              | ion>        |        |              |      |         |      |   |  |
| Quiescence  | (DVDD)      | ISSD   | -            | 0.45 | 1.5     | mA   | CMD_RS=0  |  |
|   | (MVCC)      | ISSVM  | -            | 50   | 100     | μA   |   |  |
| Operation   | (DVDD)      | IDDD   | -            | 6    | 10      | mA   |   |  |
| <logic block=""></logic>  |             |        |              |      |         |      |   |  |
| Low-level Input Volta   | age         | VIL    | DVSS         | -    | 0.3DVDD | V    |   |  |
| High-level Input Volt   | tage        | VIH    | 0.7DVDD      | -    | DVDD    | V    |   |  |
| Low-level Input Curi  | rent        | IIL    | 0            | -    | 10      | μA   | VIL=DVSS  |  |
| High-level Input Cur  | rent        | IIH    | 0            | -    | 10      | μA   | VIH=DVDD  |  |
| Low-level Output Vo   | oltage      | VOL    | DVSS         | -    | 0.2DVDD | V    | IOL=1.0mA                                       |  |
| High-level Output Voltage   |             | VOH    | 0.8DVDD      | -    | DVDD    | V    | IOH=1.0mA                                       |  |
| <pi circuit="" driving=""></pi>   |             |        |              |      |         |      |   |  |
| Output Voltage  |             | PIVO   | -            | 0.16 | 0.50    | V    | IIH=30mA  |  |
| <voltage bloc<="" driver="" td=""><td>ck 1ch-4ch&gt;</td><td></td><td></td><td></td><td></td><td></td><td></td></voltage> | ck 1ch-4ch> |        |              |      |         |      |   |  |
| ON-resistance   |             | Ron    | -            | 1.5  | 2.0     | Ω    | IO=±100mA<br>(the sum of high and low<br>sides) |  |
| OFF-leak Current  |             | IOZ    | -10          | 0    | +10     | μA   | Output Hiz setting                              |  |
| Average Voltage Accuracy between different Output Pins  |             | Vdiff  | -5           | -    | +5      | %    | Vdiff setting : 2Bh                             |  |
| <current bloc<="" driver="" td=""><td>ck 5ch,6ch&gt;</td><td></td><td></td><td></td><td></td><td></td><td></td></current> | ck 5ch,6ch> |        |              |      |         |      |   |  |
| ON-resistance   |             | Ron    | -            | 1.1  | 1.5     | Ω    | IO=±100mA<br>(the sum of high and low<br>sides) |  |
| OFF-leak Current  |             | IOZ    | -10          | 0    | +10     | μA   | Output Hiz setting                              |  |
| Output Current  |             | ю      | 190          | 200  | 210     | mA   | DAC setting : 80h<br>RRNF=1Ω                    |  |

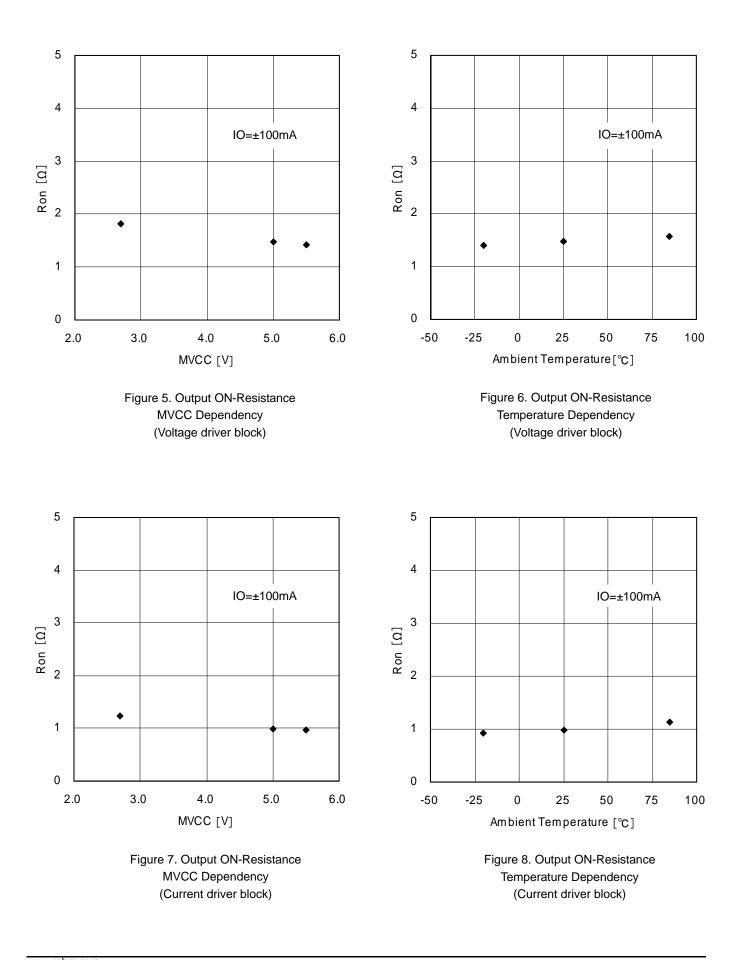
## Typical Performance Curves

(Unless otherwise specified, Ta=25°C, DVDD=3.0V, MVCC=5.0V, DVSS=MGND=0.0V)



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(Unless otherwise specified, Ta=25°C, DVDD=3.0V, MVCC=5.0V, DVSS=MGND=0.0V)



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(Unless otherwise specified, Ta=25°C, DVDD=3.0V, MVCC=5.0V, DVSS=MGND=0.0V)

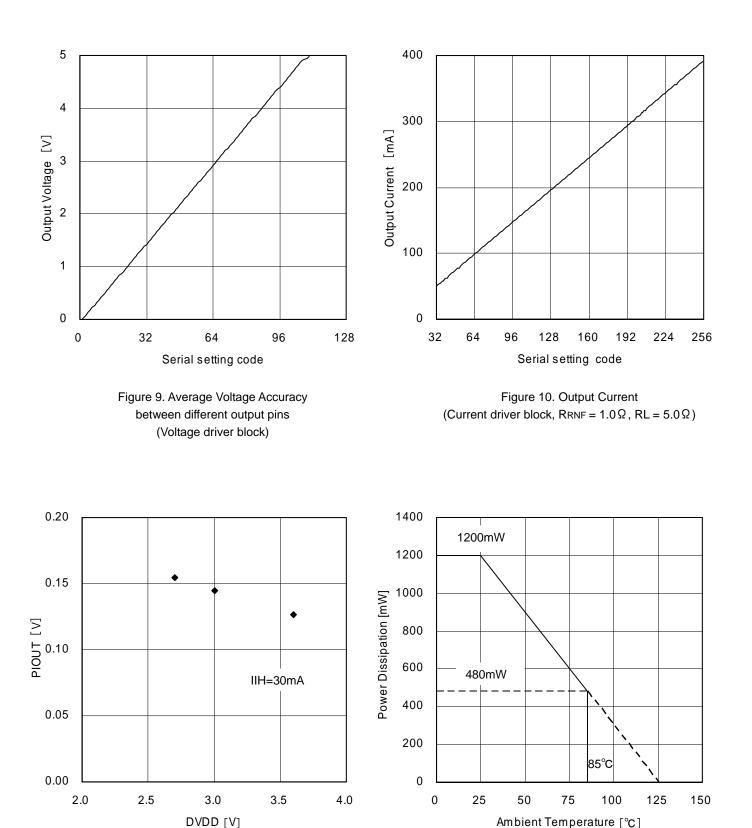


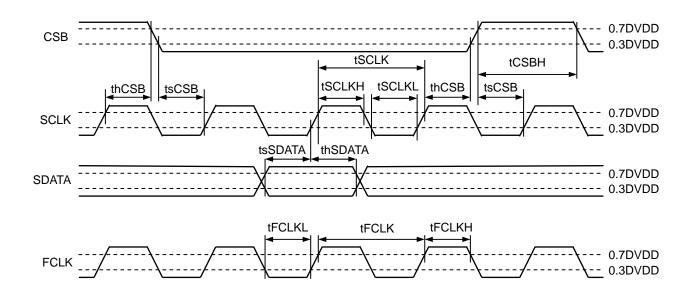


Figure 11. Output Voltage

DVDD Dependency (PI driving circuit)

## Timing Chart

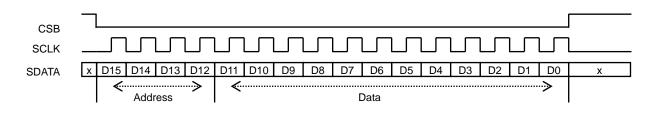
| Parameter               | Symbol  | Specification      |  |  |
|-------------------------|---------|--------------------|--|--|
| SCLK input cycle        | tSCLK   | More than 125 nsec |  |  |
| SCLK L-level input time | tSCLKL  | More than 50 nsec  |  |  |
| SCLK H-level input time | tSCLKH  | More than 50 nsec  |  |  |
| SDATA setup time        | tsSDATA | More than 50 nsec  |  |  |
| SDATA hold time         | thSDATA | More than 50 nsec  |  |  |
| CSB H-level input time  | tCSBH   | More than 380 nsec |  |  |
| CSB setup time          | tsCSB   | More than 50 nsec  |  |  |
| CSB hold time           | thCSB   | More than 50 nsec  |  |  |
| FCLK input cycle        | tFCLK   | More than 36 nsec  |  |  |
| FCLK L-level input time | tFCLKL  | More than 18 nsec  |  |  |
| FCLK H-level input time | tFCLKH  | More than 18 nsec  |  |  |



(note1) FCLK is asynchronous with SCLK. (note2) Duty of FCLK, SCLK are free.

#### Serial interface

Control commands are framed by a 16-bit serial input (MSB first) and are sent through the CSB, SCLK, and SDATA pins. The 4 higher-order bits specify addresses, while the remaining 12 bits specify data. Data of every bit is sent through SDATA pin, which is retrieved during the rising edge of SCLK. Data becomes valid when CSB is Low. The load timing is different for resistors. (as shown in "Note4, 5")



#### <Register map>

| Ac | Address[3:0] |                |    |      |        |       |          |                                     | Data           | [11:0]     |             |             |             |            |            |   |                 |  |  |  |
|----|--------------|----------------|----|------|--------|-------|----------|-------------------------------------|----------------|------------|-------------|-------------|-------------|------------|------------|---|-----------------|--|--|--|
| 15 | 14           | 13             | 12 | 11   | 10     | 9     | 8        | 7                                   | 6              | 5          | 4           | 3           | 2           | 1          | 0          |   |                 |  |  |  |
| 0  | 0            | 0              | 0  | Mode | A[1:0] | SelA  | [1:0]    | 0 Ach_different_output_voltage[6:0] |                |            |             |             |             |            |            |   |                 |  |  |  |
|    |              |                |    | 0    | 0      | 0     | 0        |                                     |                |            | Ach_C       | vcle[7:0]   |             |            |            |   |                 |  |  |  |
| 0  | 0 0 0 1      |                | 1  | 0    | 0      | 1     | 0        |                                     |                |            | Ach_Cy      | cle[15:8]   |             |            |            |   |                 |  |  |  |
| 0  | 0            | 0              | 1  | 0    | 1      | 1     | 0        | A_BEXC                              | 0              | 0          | A_BSL       | A_AEXC      | 0           | 0          | A_ASL      |   |                 |  |  |  |
|    |              |                |    | 1    | 1      | 1     | 0        | 0                                   | 0              | APO        | S[1:0]      | 0           | 0           | 0          | ASTOP      |   |                 |  |  |  |
| 0  | 0            | 1              | 0  | EnA  | RtA    |       |          |                                     |                | Ach_Pu     | Ilse[9:0]   |             |             |            |            |   |                 |  |  |  |
| 0  | 0            | 1              | 1  | 0    | 0      | 0     | 0        | 0                                   | 0              | 0          | 0           | 0           | 0           | 0          | 0          |   |                 |  |  |  |
| 0  | 1            | 0              | 0  | 0    | 0      | 0     | 0        | 0                                   | 0              | 0          | 0           | 0           | 0           | 0          | 0          |   |                 |  |  |  |
| 0  | 1            | 0              | 1  | 0    | 0      | 0     | 0        | 0                                   | 0              | 0          | 0           | 0           | 0           | 0          | 0          |   |                 |  |  |  |
| 0  | 1            | 1              | 0  | 0    | 0      | 0     | 0        | 0                                   | 0              | 0          | 0           | 0           | 0           | 0          | 0          |   |                 |  |  |  |
| 0  | 1            | 1              | 1  | 0    | 0      | 0     | 0        | 0                                   | 0              | 0          | 0           | 0           | 0           | 0          | 0          |   |                 |  |  |  |
| 1  | 0            | 0              | 0  | Mode | B[1:0] | SelE  | 8[1:0]   | 0                                   |                | E          | Bch_differe | ent_output_ | voltage[6:0 | 0]         |            |   |                 |  |  |  |
|    |              |                |    | 0    | 0      | 0     | 0        |                                     | Bch_Cycle[7:0] |            |             |             |             |            |            |   |                 |  |  |  |
|    |              |                |    |      |        |       |          |                                     |                |            |             |             | 0           | 0          | 1          | 0 | Bch_Cycle[15:8] |  |  |  |
|    |              |                |    | 0    | 1      | 1     | 0        | B_BEXC                              | 0              | 0          | B_BSL       | B_AEXC      | 0           | 0          | B_ASL      |   |                 |  |  |  |
| 1  | 0            | 0              | 1  | 1    | 0      | 0     | 0        | 0                                   | 0              | 3_Cho      | op[1:0]     | 0           | 0           | 4_Cł       | nop[1:0]   |   |                 |  |  |  |
|    |              |                |    | 1    | 0      | 1     | 3_PWM    | 1_Ct[1:0] 3ch_PWM_Duty[6:0]         |                |            |             |             |             |            |            |   |                 |  |  |  |
|    |              |                |    | 1    | 1      | 0     | 4_PWM    | L_Ct[1:0]                           |                |            | 4ch_        | PWM_Duty    | /[6:0]      |            |            |   |                 |  |  |  |
|    |              |                |    | 1    | 1      | 1     | 0        | 0                                   | 0              | BPO        | S[1:0]      | 0           | 0           | 0          | BSTOP      |   |                 |  |  |  |
| 1  | 0            | 1              | 0  | EnB  | RtB    |       |          |                                     |                | Bch_Pu     | Ilse[9:0]   |             |             |            |            |   |                 |  |  |  |
| 1  | 0            | 1              | 1  | 0    | 0      | 0     | 0        | 0                                   | 0              | 0          | 0           | 0           | 0           | 0          | 0          |   |                 |  |  |  |
| 1  | 1            | 0              | 0  | 0    | 0      | Chopp | ing[1:0] | CacheM                              | 0              | 0          | 0           | P_CTRL      | C           | LK_DIV[2   | :0]        |   |                 |  |  |  |
|    |              |                |    | 0    | 0      | 0     | 0        | 0                                   | 0              | 0          | 0           | 0           | 0           | PI_CTRL    | 1 PI_CTRL2 |   |                 |  |  |  |
| 1  | 1            | 0              | 1  | 0    | 0      | 1     | 0        | 0                                   | 0              | 0          | 0           | 5_Se        | l[1:0]      | 5_Cł       | nop[1:0]   |   |                 |  |  |  |
|    |              |                |    | 0    | 1      | 0     | 5_PWM    | I_Ct[1:0]                           |                |            | 5ch_        | PWM_Duty    | /[6:0]      |            |            |   |                 |  |  |  |
|    |              |                |    | 0    | 0      | 0     | 0        | Cui                                 | rent driver    | reference  | voltage ad  | justment6 ( | DAC6 out    | out value) | [7:0]      |   |                 |  |  |  |
| 1  | 1            | 1              | 0  | 0    | 1      | 0     | 0        | 7ch_S                               | 0              | 7_PWM      | _Ct[1:0]    | 6ch_S       | 0           | 6_PWI      | M_Ct[1:0]  |   |                 |  |  |  |
|    |              |                | 0  | 1    | 0      | 0     | 0        | Cui                                 | rent driver    | reference  | voltage ad  | justment7 ( | DAC7 out    | out value) | [7:0]      |   |                 |  |  |  |
|    |              |                |    | 1    | 1      | 0     | 0        | 0                                   | 0              | 0          | 0           | 0           | 0           | 0          | CMD_RS     |   |                 |  |  |  |
|    |              | es of<br>se ab |    |      |        |       |          | Daharana                            | Setting p      | orohibited |             |             |             |            |            |   |                 |  |  |  |

(Note 1) The notations A, B, in the register map correspond to Ach, Bch respectively.

(Note 2) The Ach is defined as 1ch and 2ch driver output, the Bch as 3ch and 4ch driver output.

(Note 3) After reset (Power ON reset, and CMD\_RS), "initial setting" is saved in all registers. (Note 4) For Mode, different output voltage, Cycle, En, and Rt registers, data that are written before the access to the Pulse register becomes valid, and determines the rising edge of CSB after the access to the Pulse register. (The Mode, different output voltage, Cycle, En, Rt, and Pulse registers contain Cache registers. Any registers other than those do not contain Cache

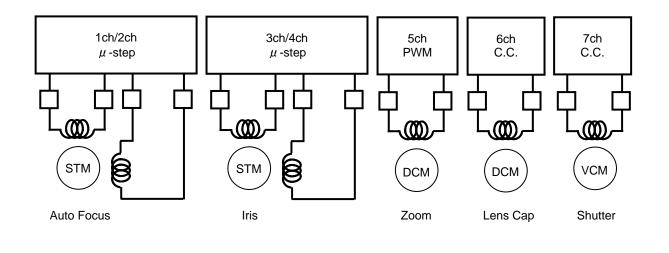
registers.)

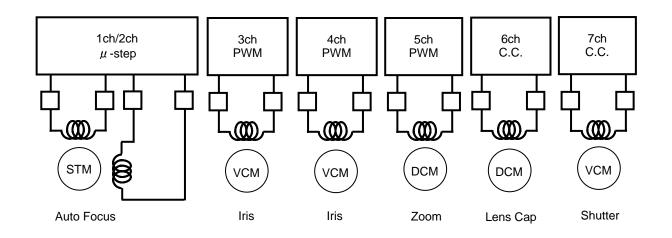
(Note 5) For POS, STOP, chop, PWM\_Ct, and PWM\_duty registers, data are determined at the rising edge of CSB. For any registers other than those, data are determined at the rising edge of 16th SCLK.

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## Application Example

- - -





# BU24024GU

## ●I/O Equivalence Circuit

| Pin  | Equivalent Circuit Diagram | Pin                              | Equivalent Circuit Diagram |
|--|----------------------------|----------------------------------|----------------------------|
| FCLK<br>CSB<br>SCLK<br>SDATA<br>IN7A<br>IN7B |                            | PIOUT1<br>PIOUT2                 |                            |
| STATE11<br>STATE12<br>STATE21<br>STATE22     |                            | OUT1A<br>OUT1B<br>OUT2A<br>OUT2B |                            |
| OUT3A<br>OUT3B<br>OUT4A<br>OUT4B             |                            | OUT5A<br>OUT5B                   |                            |
| OUT6A<br>OUT6B                               |                            | OUT7A<br>OUT7B                   |                            |

### Operational Notes

1) Absolute maximum ratings

If applied voltage, operating temperature range, or other absolute maximum ratings are exceeded, the LSI may be damaged. Do not apply voltages or temperatures that exceed the absolute maximum ratings. If you expect that any voltage or temperature could be exceeding the absolute maximum ratings, take physical safety measures such as fuses to prevent any conditions exceeding the absolute maximum ratings from being applied to the LSI.

2) GND potential

The voltage of the ground pin must be the lowest voltage of all pins of the IC at all operating conditions. Ensure that no pins are at a voltage below the ground pin at any time, even during transient condition.

3) Thermal design

Use a thermal design that allows for a sufficient margin by taking into account the permissible power dissipation (PD) in actual operating conditions.

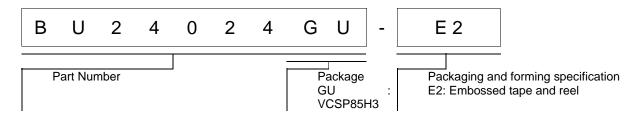
- 4) Short circuit between pins and malfunctions Ensure that when mounting the IC on the PCB the direction and position are correct. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.
- 5) Operation in strong magnetic field Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.
- 6) Power ON sequence To turn ON the DVDD, be sure to reset at CMD\_RS register.
- 7) Thermal shutdown

The IC incorporates a built-in thermal shutdown circuit, which is designed to turn off the IC when the internal temperature of the IC reaches a specified value. It is not designed to protect the IC from damage or guarantee its operation. Do not continue to operate the IC after this function is activated. Do not use the IC in conditions where this function will always be activated.

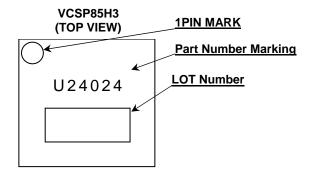
8) PI drive circuit

The output voltage of PIOUT should not exceed the voltage of the power supply voltage DVDD.

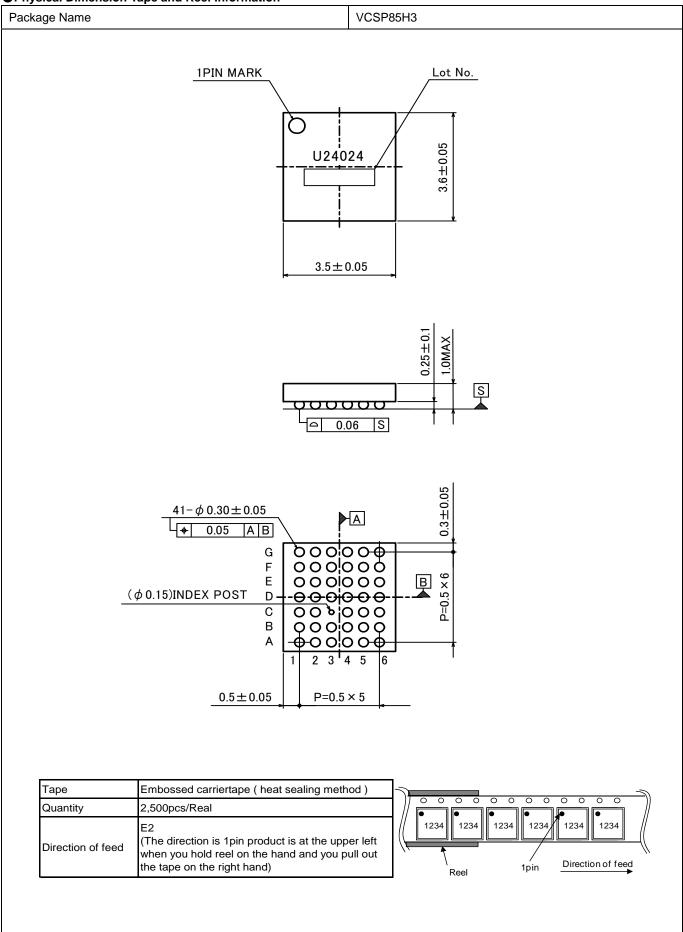
## Ordering Information



Marking Diagram



## Physical Dimension Tape and Reel Information



### Revision History

| Date        | Revision | Changes  |
|-------------|----------|--|
| 26.Sep.2012 | 001      | New Release  |
| 18.Apr.2013 | 002      | Update some English words, sentences, description, grammar and formatting. |

# Notice

#### Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

| JAPAN  | USA E  |            | CHINA   |
|--------|--------|------------|---------|
| CLASSⅢ |        | CLASS II b |         |
| CLASSⅣ | CLASSⅢ | CLASSⅢ     | CLASSII |

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
  - [a] Installation of protection circuits or other protective devices to improve system safety
  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

QR code printed on ROHM Products label is for ROHM's internal use only.

#### Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

#### Precaution for Foreign Exchange and Foreign Trade act

Since our Products might fall under controlled goods prescribed by the applicable foreign exchange and foreign trade act, please consult with ROHM representative in case of export.

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